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YESTech to Showcase 3-D X-Ray, New F1 Series AOI and Conformal Coating Inspection Solutions at IPC Midwest 2008

San Clemente, CA – September 18, 2008 - YESTech, a leading supplier of automated optical and x-ray inspection systems for the electronics industry, will showcase its new X3, 3-D X-Ray inspection, F1 AOI and B-UV automated conformal coating inspection systems - at this years IPC Midwest, held on September 24-25, Booth 900 at Renaissance Schaumburg Hotel & Convention Center in Schaumburg, Illinois.

YESTech's complete line of AOI and X-Ray inspection systems offer manufacturers the latest technologies and cost-effective inspection solutions. The innovative new X-Series Automated X-Ray Inspection System (AXI) provides electronics manufacturers advanced 3-D inspection capability for fast and complete inspection of PCBs with BGAs and other hidden solder joints. The X3's unique ability to selectively use 2-D or 3-D technology to inspect specific regions of interest on a board provides a critical advantage of balancing double sided inspection and throughput. In addition, the X3's proprietary imaging technology rapidly gathers multiple oblique images of the sample to construct a 3 dimensional rendering used in identifying solder and component related defects on both single and double-sided boards. When integrated with YESTech AOI inspection, these systems can increase fault coverage to include nearly all process defects.

The F1-Series AOI system provides for advanced inspection of solder and lead defects, component presence and position, correct part, polarity and through-hole parts. The F1-Series is ideally suited for high-volume or high mix manufacturing environments and helps to increase throughput, improve quality and reduce costs. It is equally effective for pre/post-reflow applications. The system's four advanced oblique viewing cameras offer critical inspection capabilities for R-nets and other difficult to inspect parts. YESTech's newly improved **Fusion Lighting™**, with multi-color solder joint inspection, delivers 20% higher detection capabilities when compared to previous models. The F1 Series AOI offers off-line programming and utilizes a standard package library to simplify training and ensure program portability across manufacturing lines. Real-time SPC monitoring is a standard option.

The YESTech B-UV makes inspection of conformal coatings simple and convenient by automating the inspection process for quality, consistency and thickness of coatings under UV lighting, with the use of proprietary inspection algorithms. The B-UVs advanced inspection algorithms provide fast and completely automated inspection for coverage, selected areas of non-coverage, de-lamination, cracks and bubbles.

"We are very pleased to be showcasing our newest inspection solutions at this years IPC Midwest show," said YESTech president Don Miller. "This show presents an ideal opportunity to meet with our valued clients in the mid-west and introduce our latest inspection solutions. "

Editor's Note

A high-resolution image of the X-Series and next generation F1 Series and B-UV is available by calling (949) 439-5351 or by visiting http://www.kreativesolution.com/yestech-ipc_08.htm. For pricing and availability call YESTech's USA HQ at: 949-361-2714 or visit the YESTech website at <http://www.yestechinc.com>

About IPC

IPC is a global trade association based in Bannockburn, Ill., dedicated to the competitive excellence and financial success of its 2,700 member companies which represent all facets of the electronics industry, including design, printed board manufacturing, electronics assembly and test. As a member-driven organization and leading source for industry standards, training, market research and public policy advocacy, IPC supports programs to meet the needs of an estimated \$1.5 trillion global electronics industry. IPC maintains additional offices in Taos, N.M.; Arlington, Va.; Garden Grove, Calif.; Stockholm, Sweden; and Shanghai, China. For more information visit <http://www.ipc.org>

About YESTech

Headquartered in San Clemente, California, YESTech is a leading provider of automated optical and high-resolution x-ray inspection systems, with integrated yield enhancement solutions for the printed circuit board assembly and advanced semiconductor-packaging industries. Founded in 2002 and acquired in 2007 as a subsidiary of Nordson Corporation (Nasdaq:NDSN), YESTech is operated and managed by a team of industry experts with a history of success, bringing powerful and cost-effective inspection to the electronics market. The company has sales offices and customer support centers in North America, Asia and Europe. For more information on YESTech and its products, visit www.yestechinc.com For more information on Nordson Corporation visit <http://www.nordson.com>

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